

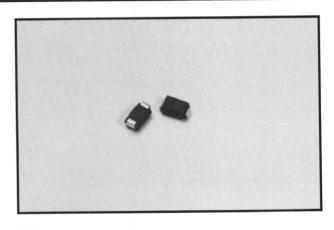
# 1 AMP SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

#### **FEATURES**

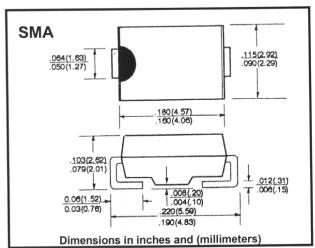
- For surface mount applications
- Metal semiconductor junction with guard ring
- Epitaxial construction
- Low forward voltage drop
- UL recognized 94V-O plastic material
- Lead solderable per MIL-STD-202 Method 208
- Surge overload rating to 30A peak

#### Mechanical Data

- Case: Molded plastic
- Polarity: Indicated on cathode
- Weight: 0.002 ounces, 0.064 grams



## Outline Drawing



### Maximum Ratings & Characteristics

- Ratings at 25° C ambient temperature unless otherwise specified
- Single phase, half wave, 60Hz, resistive or inductive load
- For capacitive load, derate current by 20%

		B120	B130	B140	B150	B160	Units
Maximum Recurrent Peak Reverse Voltage	VRRM	20	30	40	50	60	V
Maximum RMS Input Voltage	V <sub>RMS</sub>	14	21	28	35	42	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	20	30	40	50	60	V
Maximum Average Forward Output Current	1,000	I (AV) 1.0					А
.375" 9.5mm lead length @ T <sub>L</sub> = 100°C	' (AV)						
Peak Forward Surge Current		30					A
8.3 ms Single Half-Sine-Wave	IFSM						
Superimposed On Rated Load							
MaximumForward Voltage Drop At 1.0A	VF	0.50 0.70			70	V	
Maximum Reverse Current At Rated @ T <sub>A</sub> = 25°C	lp.	l <sub>R</sub> 0.5					mA
DC Blocking Voltage per Bridge Element @ T <sub>A</sub> = 100°C	ir.	1.0				mA	
Typical Junction Capacitance *(See Note)	CJ	C <sub>J</sub> 110					pF
Maximum Thermal Resistance**(See Note)	R <sub>(THJL)</sub>	HJL) 10				°C/W	
Operating Temperature Range	TJ	-65 to +150				°C	
Storage Temperature Range	T <sub>STG</sub>	-65 to +150					°C

Note:

- \*Measured at 1.0 MHZ and applied reverse voltage of 4.0V DC
- \*\*Thermal resistance junction to lead, measured on PC board 5mm<sup>2</sup> X (0.013mm thick)